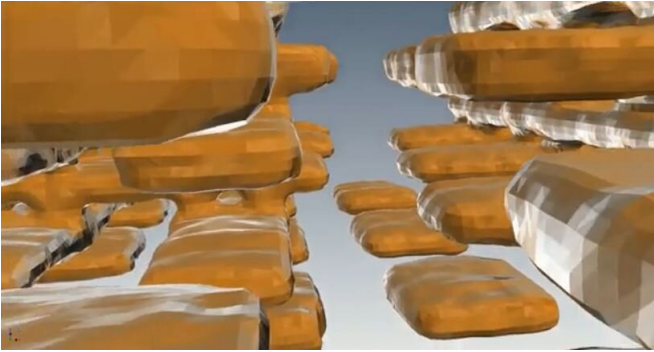


Groundbreaking method detects defective computer chips

7 October 2019



Guaranteeing that computer chips, that can consist of billions of interconnected transistors, are manufactured without defects is a challenge. But how to determine if a chip is compromised?

Now a technique co-developed by researchers at the Paul Scherer Institut in Switzerland and researchers at the USC Viterbi School of Engineering would allow companies and other organizations to non-destructively scan chips to ensure that they haven't been altered and that they are manufactured to design specifications without error.

Hardware security is a critical issue. Anthony F. J. Levi, Department Chair of the Ming Hsieh Department of Electrical Engineering-Electrophysics, co-author of the study, "Three-dimensional imaging of integrated circuits with macro- to nanoscale zoom" published in *Nature Electronics*, says that "the [supply chain](#) for advanced electronics is susceptible."

With this new method, it is possible to validate the integrity of [computer chips](#) using [x-rays](#).

Called ptychographic X-ray laminography, the

technique utilizes x-rays from a synchrotron to illuminate a small region of a rotating chip at an angle of 61 degrees (with respect to the normal of the chip plane). The resulting diffraction patterns are measured with a photon-counting detector array. The data are then used to generate high-resolution slice images of the chip, from which 3-D renderings are created.

Once the 3-D image is generated, it can be compared with the original design as a type of forensics to help companies or organizations that are looking to ensure chips are manufactured correctly and meet design specifications.

The researchers indicate that chips have signature features, so it is possible to tell how and where they were manufactured.

In addition, this process allows for reverse engineering of circuit designs without destroying the chip.

Levi says, "The majority of a chip's intelligence is how it is wired. It is like the connectome of a brain. By viewing a chip in detail, you can non-destructively figure out what it does. With this technology, hiding [intellectual property](#) in a [chip](#) is over."

Levi imagines that the technology could one day contribute to a [certification process](#) to ensure the integrity of chips that are inserted into a computer or in communication hardware used by global businesses and governments.

The next steps are to continue to improve imaging speed and resolution and to further improve X-ray microscope performance.

More information: Three-dimensional imaging of integrated circuits with macro- to nanoscale zoom, *Nature Electronics* (2019). [DOI: 10.1038/s41928-019-0309-z](#) ,

www.nature.com/articles/s41928-019-0309-z

Provided by University of Southern California

APA citation: Groundbreaking method detects defective computer chips (2019, October 7) retrieved 19 June 2021 from <https://techxplore.com/news/2019-10-groundbreaking-method-defective-chips.html>

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